

MSR-FIC50A12F-C10-L35 V1.1 50MP Samsung S5KJN1SQ03 MIPI Interface Fixed Focus Camera Module





Front View Back View

Specifications

| Camera Module No. | MSR-FIC50A12F-C10-L35 V1.1 | | |
|--------------------------|---------------------------------------|--|--|
| Resolution | 50MP | | |
| Image Sensor | S5KJN1SQ03 | | |
| Sensor Type | 1/2.76" | | |
| Pixel Size | 0.64 um x 0.64 um | | |
| EFL | 5.60 mm | | |
| F.NO | 2.20 | | |
| Pixel | 8160 x 6144 | | |
| View Angle | 129.0°(DFOV) 104.1°(HFOV) 83.7°(VFOV) | | |
| Lens Dimensions | 8.50 x 8.50 x 6.45 mm | | |
| Module Size | 35.00 x 9.00 mm | | |
| Module Type | Fixed Focus | | |
| Interface | MIPI | | |
| Auto Focus VCM Driver IC | None | | |
| Lens Type | 650nm IR Cut | | |
| Operating Temperature | -20°C to +85°C | | |
| Mating Connector | BAF04-30083-0500 | | |



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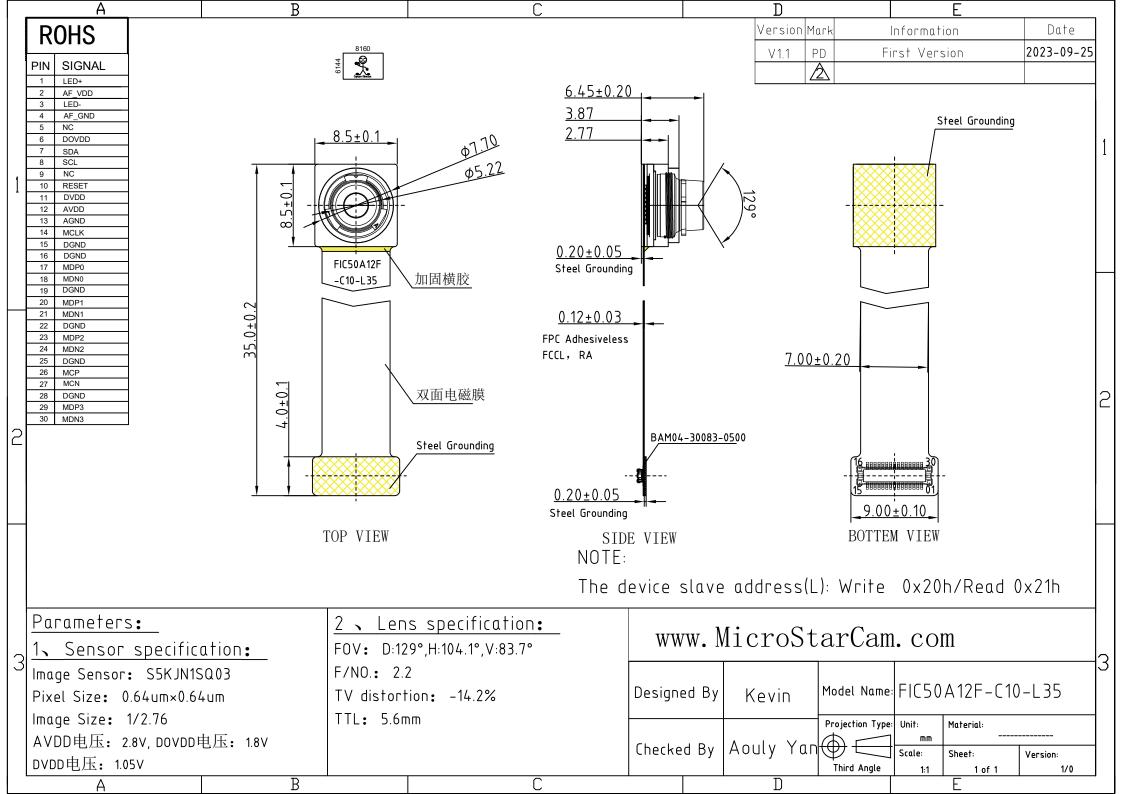


Top View Side View



Bottom View

Mating Connector



S5KJN1SQ03

1/2.76" 50M CMOS Image Sensor for 2x2 TetraCell RGB Bayer Pattern

Revision 0.12 Mar 2022

G5A G1 B; '7cbZXYbhJU'
5J D'9@97HFCB=7G'@A +198'#V]`mU]'Un'&\$&&"\$*"&\$

Data Sheet

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Product Overview

1.1 Introduction

S5KJN1SQ03 is a highly integrated 50 MP camera chip with a CMOS Image Sensor (CIS), image correction functionality and serial transmission capability using 4-lane MIPI. It is designed for fast and low-power operation to deliver full resolution capture at 10 frames per second (fps) and full field of view (4:3) 12.5 MP video at 30 fps.

S5KJN1SQ03 has 2x2 Tetra-Cell RGB Bayer pattern. Each color channel of 2x2 Tetra-Cell RGB Bayer pattern is composed of four pixels of one color filter and its shape is 2x2 square. S5KJN1SQ03 has two output modes. One is binning output mode in which the adjacent same color pixels are summed. The other is normal output mode without binning, but there are changes in the order of output sequence of the real pixel array. In normal output mode, remosaic algorithm is necessary to reconstruct normal Bayer image.

S5KJN1SQ03 is fabricated by the Samsung CMOS image sensor process, which realizes a high-efficiency and low-power photo sensor. The sensor consists of 8160x6144 effective pixels that meets the 1/2.76-inch optical format.

S5KJN1SQ03 CIS has on-chip 10-bit ADC arrays to digitize the pixel output and on-chip Correlated Double Sampling (CDS) to drastically reduce Fixed Pattern Noise (FPN). It incorporates on-chip camera functions such as dark level compensation, defect correction, exposure setting, and white balance setting.

S5KJN1SQ03 CIS is programmable through a CCI or SPI serial interface and includes on-chip One-Time Programmable (OTP) Non-Volatile Memory (NVM).

S5KJN1SQ03 is suitable for a low-power camera module with a 2.8 V/1.8 V/1.05 V power supply.



1.2 Features

S5KJN1SQ03 supports the following features:

- 50 MP sensor with 1/2.76-inch optics
- Unit pixel size: 0.64 μm
- Effective resolution: 8160 (H) × 6144 (V)
- Active resolution: 8192 (H) × 6176 (V)
- Color filter: 2x2 Tetra-Cell RGB Bayer pattern
- Shutter type: Electronic rolling shutter and global reset
- Max. normal frame rate: 10 fps @ Full
- Max. video frame rate: 30 fps (2x2 FDSUM) @ 12.5 MP
- Data rate: 2,150 Mbps/lane
- ADC accuracy: 10 bits
- Double Super PD for faster autofocus even in dark environments
- Dual sensor synchronize
- Interfaces
 - Fine interface frequency control using additional dedicated PLL for integration flexibility and to avoid EMI
 - MIPI CSI2: 4 lanes (2.15 Gbps per lane)
 - Output formats: RAW10
- Control interface
 - SPI interface: Four-wire serial communication circuit up to 20 MHz
 - Camera Control Interface (CCI) high-speed I2C-compatible Two-wire serial communication circuit up to 1 MHz
- 512Bytes of On-chip OTP memory for users
- Maximum Analog Gain of x16: Full mode
- Maximum Analog Gain of x64: 2x2 FD sum mode
- Vertical flip and horizontal mirror mode
- 4-SUM mode support
- Mapped bad pixel correction
- Interscene DCG function
- Built-in test pattern generation
- Supply voltage: 2.8 V for analog, 1.8 V for I/O, and 1.05 V for digital core supply
- Operating temperature: -20°C to +85°C





Cameras Applications





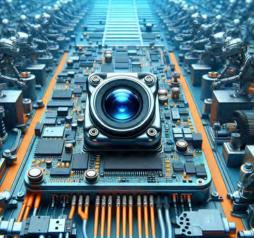


Automotive Driver Pilot

Live Streaming

Video Conference







Eye Tracker Biometric Detection

Machine Vision

Agricultural Monitor







Night Vision Security

Drone and Sports Eagle Eyes

Interactive Pet Camera



Camera Module Pinout Definition Reference Chart

| OmniVision Sony Samsung On-Semi Aptina Himax GalaxyCore PixArt SmartSens Sensors | | | | | |
|--|---|--|--|--|--|
| Pin Signal | Description | | | | |
| DGND GND | ground for digital circuit | | | | |
| AGND | ground for analog circuit | | | | |
| PCLK DCK | DVP PCLK output | | | | |
| XCLR PWDN XSHUTDOWN STANDBY | power down active high with internal pull-down resistor | | | | |
| MCLK XVCLK XCLK INCK | system input clock | | | | |
| RESET RST | reset active low with internal pull-up resistor | | | | |
| NC NULL | no connect | | | | |
| SDA SIO_D SIOD | SCCB data | | | | |
| SCL SIO_C SIOC | SCCB input clock | | | | |
| VSYNC XVS FSYNC | DVP VSYNC output | | | | |
| HREF XHS | DVP HREF output | | | | |
| DOVDD | power for I/O circuit | | | | |
| AFVDD | power for VCM circuit | | | | |
| AVDD | power for analog circuit | | | | |
| DVDD | power for digital circuit | | | | |
| STROBE FSTROBE | strobe output | | | | |
| FSIN | synchronize the VSYNC signal from the other sensor | | | | |
| SID | SCCB last bit ID input | | | | |
| ILPWM | mechanical shutter output indicator | | | | |
| FREX | frame exposure / mechanical shutter | | | | |
| GPIO | general purpose inputs | | | | |
| SLASEL | I2C slave address select | | | | |
| AFEN | CEN chip enable active high on VCM driver IC | | | | |
| MIPI Interface | 3 | | | | |
| MDN0 DN0 MD0N DATA_N DMO1N | MIPI 1st data lane negative output | | | | |
| MDP0 DP0 MD0P DATA P DMO1P | MIPI 1st data lane negative output | | | | |
| MDN1 DN1 MD1N DATA2 N DMO2N | MIPI 2nd data lane negative output | | | | |
| MDP1 DP1 MD1P DATA2 P DMO2P | MIPI 2nd data lane positive output | | | | |
| MDN2 DN2 MD2N DATA3 N DMO3N | MIPI 3rd data lane negative output | | | | |
| MDP2 DP2 MD2P DATA3 P DMO3P | MIPI 3rd data lane positive output | | | | |
| MDN3 DN3 MD3N DATA4 N DMO4N | MIPI 4th data lane negative output | | | | |
| MDP3 DP3 MD3P DATA4_P DMO4P | MIPI 4th data lane negative output | | | | |
| MCN CLKN CLK_N DCKN | MIPI clock negative output | | | | |
| MCP CLKP MCP CLK_P DCKN | MIPI clock positive output | | | | |
| DVP Parallel Interface | | | | | |
| D0 D00 Y0 | DVP data output port 0 | | | | |
| D1 D01 Y1 | DVP data output port 1 | | | | |
| D2 DO2 Y2 | DVP data output port 2 | | | | |
| D3 DO3 Y3 | DVP data output port 3 | | | | |
| D4 DO4 Y4 | DVP data output port 4 | | | | |
| D5 DO5 Y5 | DVP data output port 5 | | | | |
| D6 D06 Y6 | DVP data output port 6 | | | | |
| D7 D07 Y7 | DVP data output port 7 | | | | |
| D8 DO8 Y8 | DVP data output port 8 | | | | |
| D9 DO9 Y9 | DVP data output port 9 | | | | |
| D10 DO10 Y10 | DVP data output port 10 | | | | |
| D11 D011 Y11 | DVP data output port 11 | | | | |
| ווו ווטס ווס | DVI data output port 11 | | | | |



Camera Reliability Test

| Reliability Inspection Item | | Tasting Mathad | A cooptoned Cuitoria | |
|-----------------------------|--------------------------------|---|-------------------------|-------------------------|
| Category | | Item | Testing Method | Acceptance Criteria |
| Environmental | Storage | High 60°C 96 Hours | Temperature Chamber | No Abnormal Situation |
| | Temperature | Low -20°C 96 Hours | Temperature Chamber | No Abnormal Situation |
| | Operation Temperature | High 60°C 24 Hours | Temperature Chamber | No Abnormal Situation |
| | | Low -20°C 24 Hours | Temperature Chamber | No Abnormal Situation |
| | Humidity | 60°C 80% 24 Hours Temperature Chambe | | No Abnormal Situation |
| | Thermal Shock | High 60°C 0.5 Hours Low -20°C 0.5 Hours Cycling in 24 Hours | Temperature Chamber | No Abnormal Situation |
| Dhusiael | Drop Test (Free Falling) | Without Package 60cm | 10 Times on Wood Floor | Electrically Functional |
| | | With Package 60cm | 10 Times on Wood Floor | Electrically Functional |
| | Vibration Test | 50Hz X-Axis 2mm 30min | Vibration Table | Electrically Functional |
| | | 50Hz Y-Axis 2mm 30min | Vibration Table | Electrically Functional |
| Physical | | 50Hz Z-Axis 2mm 30min | Vibration Table | Electrically Functional |
| | Cable Tensile Strength Test | Loading Weight 4 kg 60 Seconds Cycling in 24 Hours | Tensile Testing Machine | Electrically Functional |
| Electrical | ESD Test | Contact Discharge 2 KV | ESD Testing Machine | Electrically Functional |
| | | Air Discharge 4 KV | ESD Testing Machine | Electrically Functional |
| | Aging Test | On/Off 30 Seconds Cycling in 24 Hours | Power Switch | Electrically Functional |
| | USB Connector | On/Off 250 Times | Plug and Unplug | Electrically Functional |











Camera Inspection Standard

| Inspection Item | | | | | |
|-----------------|-----------|------------------|-------------------|--|--|
| Category | | Item | Inspection Method | Standard of Inspection | |
| | FPC / PCB | Color | The Naked Eye | Major Difference is Not Allowed. | |
| | | Be Torn/Chopped | The Naked Eye | Copper Crack Exposure is Not Allowed. | |
| | | Marking | The Naked Eye | Clear, Recognizable (Within 30cm Distance) | |
| | | Scratches | The Naked Eye | The Inside Crack Exposure is Not Allowed | |
| | Holder - | Gap | The Naked Eye | Meet the Height Standard | |
| Appearance | | Screw | The Naked Eye | Make Sure Screws Are Presented (If Any) | |
| | | Damage | The Naked Eye | The Inside Crack Exposure is Not Allowed | |
| | | Scratch | The Naked Eye | No Effect On Resolution Standard | |
| | Lens - | Contamination | The Naked Eye | No Effect On Resolution Standard | |
| | | Oil Film | The Naked Eye | No Effect On Resolution Standard | |
| | | Cover Tape | The Naked Eye | No Issue On Appearance. | |
| | | No Communication | Test Board | Not Allowed | |
| | Image | Bright Pixel | Black Board | Not Allowed In the Image Center | |
| | | Dark Pixel | White board | Not Allowed In the Image Center | |
| | | Blurry | The Naked Eye | Not Allowed | |
| | | No Image | The Naked Eye | Not Allowed | |
| | | Vertical Line | The Naked Eye | Not Allowed | |
| | | Horizontal Line | The Naked Eye | Not Allowed | |
| Function | | Light Leakage | The Naked Eye | Not Allowed | |
| | | Blinking Image | The Naked Eye | Not Allowed | |
| | | Bruise | Inspection Jig | Not Allowed | |
| | | Resolution | Chart | Follows Outgoing Inspection Chart Standard | |
| | | Color | The Naked Eye | No Issue | |
| | | Noise | The Naked Eye | Not Allowed | |
| | | Corner Dark | The Naked Eye | Less Than 100px By 100px | |
| | | Color Resolution | The Naked Eye | No Issue | |
| | | Height | The Naked Eye | Follows Approval Data Sheet | |
| Dimension | | Width | The Naked Eye | Follows Approval Data Sheet | |
| | | Length | The Naked Eye | Follows Approval Data Sheet | |
| | | Overall | The Naked Eye | Follows Approval Data Sheet | |



YDS (MicroStar) Camera Module



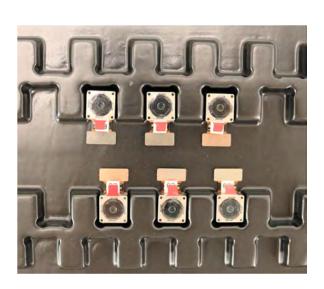
Tray with Grid and Space



Complete with Lens Protection Film



Place Cameras on the Tray





Full Tray of Cameras



Place Tray into Anti-Static Bag



Cover Tray with Lid



Vacuum the Anti-Static Bag





Sealed Vacuum Anti-Static Bag with Labels

1. Model and Description 2. Quantity 3. Manufacturing Date Code 4. Caution





Place Foam Sheets Between Tray Bags



Place Foam Sheets and Trays into Box



Seal the Carbon Box



Foam Sheets are Larger Than Trays



Foam Sheets are Tightly Fitting in Box



Label the Carbon Shipping Box





USB Camera Module

Complete with Lens Protection Film







Place Camera Sample into Anti-Static Bag

Place USB Cameras into Tray







Seal the Tray with Anti-Static Bag

nti-Static Bag Label the Carbon Shipping Box







Place Camera Sample into Anti-Static Bag





Label the Sample Bags



Place Samples into the Carbon Box



Place Connectors into Anti-Static Bag





Place Connectors into Reel



Place Connectors into the Carbon Box





About Our Company YingDeShun Co. Ltd. (Micro Star Brand)

YingDeShun Co. Ltd. (YDS) was established in 2017, a next-generation technology driven manufacturer specialized in research, design, and produce of audio and video products. The brand "Micro Star" is made by YDS. Our factories are occupying 50,000 square feet automated plants with 200 employees of annual throughput 85,000,000 units cameras.

Micro Star (YDS) provides OEM, ODM design, contract manufacturing, and builds the camera products. You may provide the requirements to us, even with a hand draft, our sales and engineering work together to meet your needs. We consider ourselves your long term partner in developing practical and innovative solutions.

Our team covers everything from initial concept development to mass produced product. Micro Star (YDS) specializes in customized camera design, raw material, electronic engineering, firmware/software development, product testing, and packing design. Our experienced strategic supply systems offer a robust and dependable manufacturing capacity for orders of various sizes.





Limited Warranty

Micro Star (YDS) provides the following limited warranty if you purchased the Product(s) directly from YDS company or from Micro Star's website www.MicroStarCam.com. Product(s) purchased from other sellers or sources are not covered by this Limited Warranty. Micro Star guarantees that the Product(s) will be free from defects in materials and workmanship under normal use for a period of one (1) year from the date you receive the product ("Warranty Period").

For all Product(s) that contain or develop material defects in materials or workmanship during the Warranty Period, Micro Star will, at its sole option, either: (i) repair the Product(s); (ii) replace the Product(s) with a new or refurbished Product(s) (replacement Product(s) being of identical model or functional equivalent); or (iii) provide you a refund of the price you paid for the Product(s).

This Limited Warranty of Micro Star is solely limited to repair and/or replacement on the terms set forth above. Micro Star is not reliable or responsible for any subsequential events.















Our Company Strength

Powerful Factory





Professional Service







Promised Delivery













